



The Delphi series Q48SK12033, quarter brick, 36~75V input, single output, isolated DC/DC converter is the latest offering from a world leader in power system and technology and manufacturing Š Delta Electronics, Inc. This product provides up to 400 watts of power in an industry standard footprint and pin out. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performances, as well as extremely high reliability under highly stressful operating conditions. The Q48SK12033 offers more than 95.5% high efficiency at 33A full load. The Q48SK12033 is fully protected from abnormal input/output voltage, current, and temperature conditions and meets all safety requirements with basic insulation.

#### **FEATURES**

- High efficiency: 95.5% @ 12V/33A
- Size:
   57.9x36.8x11.2mm (2.28"x1.45"x0.44")
   (w/o heat spreader)
   57.9\*36.8\*12.7mm(2.28"\*1.45"0.50")
   (with heat spreader)
- Standard footprint
- Industry standard pin out
- Fixed frequency operation
- Input UVLO, Output OCP, OVP, OTP
- Hiccup output over current protection
   (OCP)
- Hiccup output over voltage protection (OVP)
- Auto recovery OTP and input UVLO
- 2250V isolation and basic insulation
- No minimum load required
- ISO 9001, TL 9000, ISO 14001, QS9000, OHSAS18001 certified manufacturing facility
- UL/cUL 60950-1 (US & Canada)
   recognized

#### **OPTIONS**

- Latched over current protection
- Positive On/Off logic
- Heat spreader available for extended operation.

#### **APPLICATIONS**

- Telecom / Datacom
- Wireless Networks
- Optical Network Equipment
- Server and Data Storage
- Industrial / Testing Equipment



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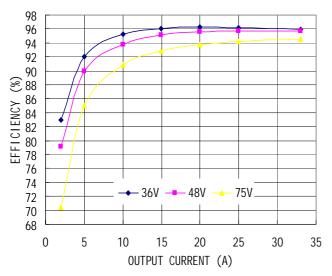


Figure 1: Efficiency vs. load current for minimum, nominal, and maximum input voltage at 85°C.

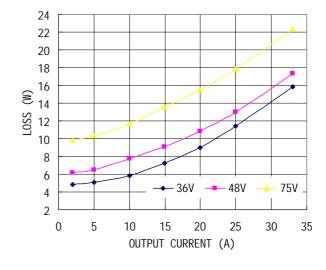


Figure 2: Power dissipation vs. load current for minimum, nominal, and maximum input voltage at 85°C.

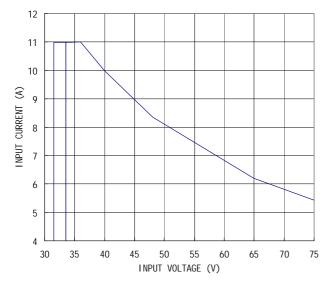


Figure 3: Typical full load input characteristics at room temperature.

# For Negative Remote On/Off Logic

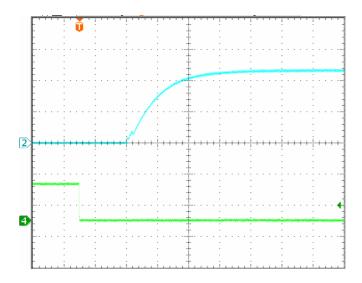
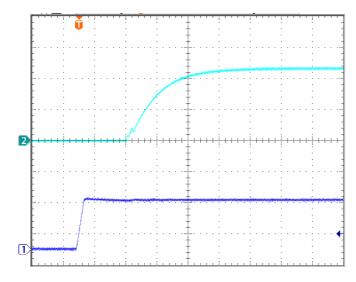
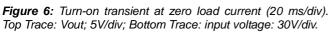


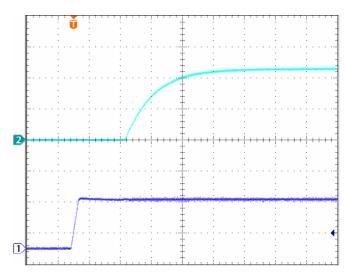
Figure 4: Turn-on transient at zero load current) (20ms/div). Top Trace: Vout; 5V/div; Bottom Trace: ON/OFF input: 2V/div.

**Figure 5:** Turn-on transient at full rated load current (20 ms/div). Top Trace: Vout: 5V/div; Bottom Trace: ON/OFF input: 2V/div.

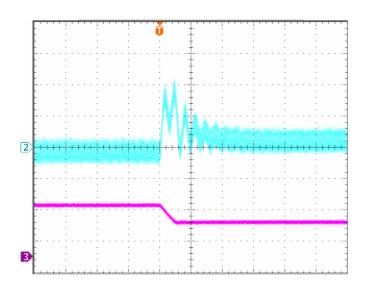
# For Input Voltage Start up



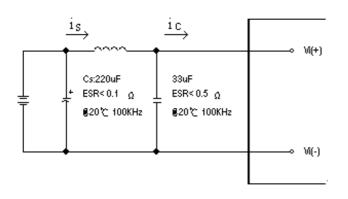




**Figure 7**: Turn-on transient at full rated load current (20 ms/div). Top Trace: Vout; 5V/div; Bottom Trace: input voltage: 30V/div.

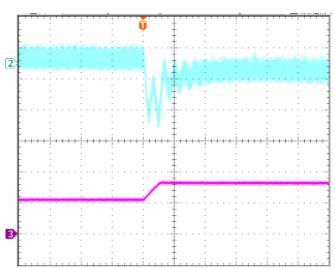


**Figure 8:** Output voltage response to step-change in load current (75%-50% of lo, max; di/dt = 0.1A/ $\mu$ s). Load cap:  $10\mu$ F, tantalum capacitor and  $1\mu$ F ceramic capacitor. Top Trace: Vout; 100mV/div; Bottom Trace: output current: 15A/div, Time: 200us/div

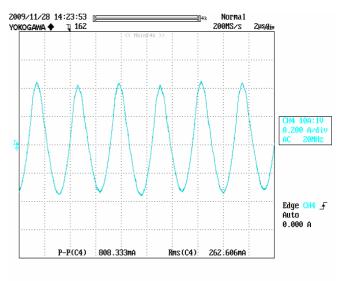


**Figure 10:** Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

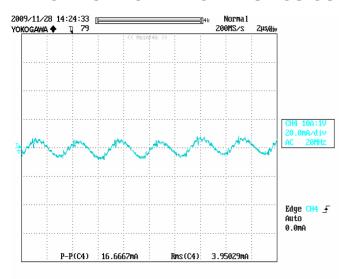
Note: Measured input reflected-ripple current with a simulated source Inductance ( $L_{TEST}$ ) of 12  $\mu$ H. Capacitor Cs offset possible battery impedance. Measure current as shown above.

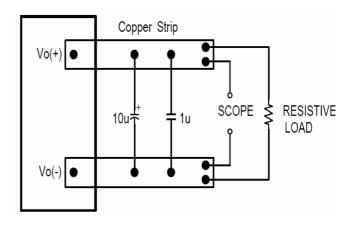


**Figure 9:** Output voltage response to step-change in load current (50%-75% of lo, max; di/dt = 0.1A/ $\mu$ s). Load cap: 10 $\mu$ F, tantalum capacitor and 1 $\mu$ F ceramic capacitor. Top Trace: Vout; 100mV/div; Bottom Trace: output current: 15A/div, Time: 200us/div



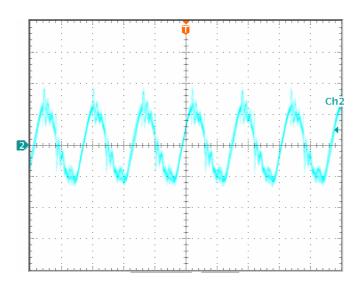
**Figure 11:** Input Terminal Ripple Current, i<sub>c</sub>, at full rated output current and nominal input voltage with 12µH source impedance and 33µF electrolytic capacitor (200 mA/div , 2us/div).





**Figure 12:** Input reflected ripple current,  $i_s$ , through a  $12\mu H$  source inductor at nominal input voltage and rated load current (20 mA/div , 2us/div).

Figure 13: Output voltage noise and ripple measurement test setup.



**Figure 14:** Output voltage ripple at nominal input voltage and rated load current (Io=33A)(20 mV/div, 2us/div)
Load capacitance: 1μF ceramic capacitor and 10μF tantalum capacitor. Bandwidth: 20 MHz.

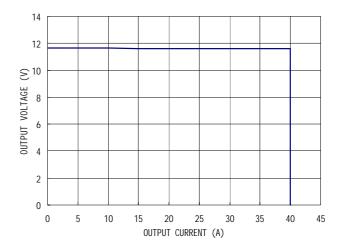


Figure 15: Output voltage vs. load current showing typical current limit curves and converter shutdown points.

# **DESIGN CONSIDERATIONS**

#### Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few  $\mu$ H, we advise adding a  $10\mu$ F to  $100\mu$ F electrolytic capacitor (ESR < 0.7 at 100 kHz) mounted close to the input of the module to improve the stability.

### Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Application notes to assist designers in addressing these issues are pending release.

# **Safety Considerations**

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e., UL60950-1, CAN/CSA-C22.2, No. 60950-1 and EN60950-1+A11 and IEC60950-1, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- If the metal baseplate is grounded, the output must be also grounded.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a normal-blow fuse with 40A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

#### **Soldering and Cleaning Considerations**

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

#### FEATURES DESCRIPTIONS

#### **Over-Current Protection**

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the modules will shut down (hiccup mode).

The modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

#### **Over-Voltage Protection**

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the protection circuit will constrain the max duty cycle to limit the output voltage, if the output voltage continuously increases the modules will shut down, and then restart after a hiccup-time (hiccup mode).

#### **Over-Temperature Protection**

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will restart after the temperature is within specification.

#### Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi (-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi (-). For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

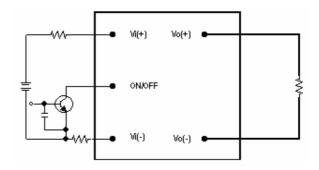


Figure 16: Remote on/off implementation

#### THERMAL CONSIDERATIONS

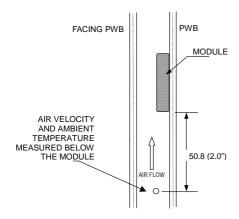
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

# **Thermal Testing Setup**

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 17: Wind tunnel test setup

#### **Thermal Derating**

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.

# THERMAL CURVES (WITHOUT HEAT SPREADER)

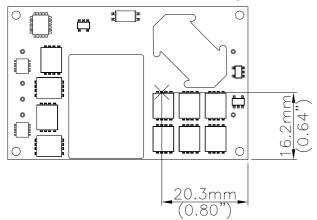
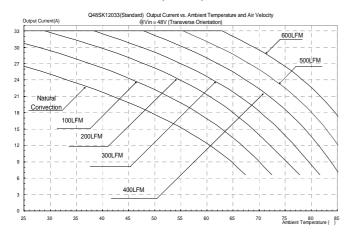


Figure 18: Temperature measurement location
\* The allowed maximum hot spot temperature is defined at 117



**Figure 19:** Output current vs. ambient temperature and air velocity @Vin=48V(Transverse Orientation, without heat spreader)

# THERMAL CURVES (WITH HEAT SPREADER)

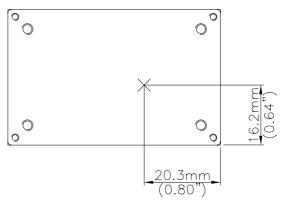
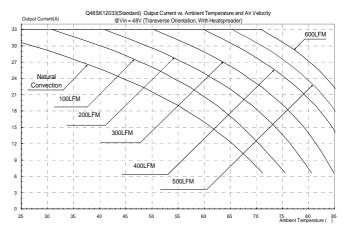


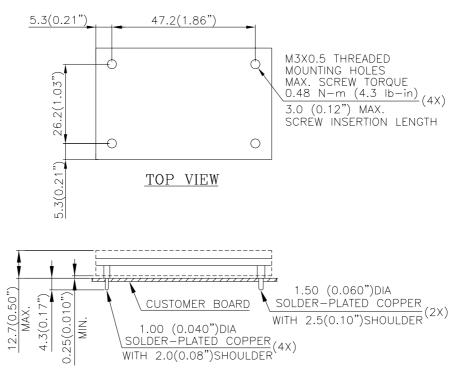
Figure 20: Temperature measurement location
\* The allowed maximum hot spot temperature is defined at 108



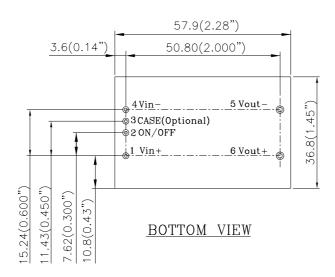
**Figure 21:** Output current vs. ambient temperature and air velocity @Vin=48V(Transverse Orientation, with heat spreader)

# **MECHANICAL DRAWING (WITH HEAT SPREADER)**

\* For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.

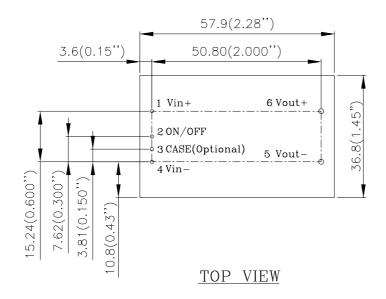


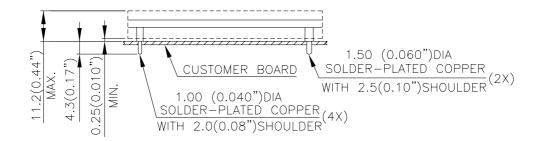
#### SIDE VIEW



NOTES:

# **MECHANICAL DRAWING (WITHOUT HEAT SPREADER)**





# SIDE VIEW

NOTES:

| Pin No. | <u>Name</u> | <b>Function</b>         |  |  |
|---------|-------------|-------------------------|--|--|
| 1       | +Vin        | Positive input voltage  |  |  |
| 2       | ON/OFF      | Remote ON/OFF           |  |  |
| 3       | Case        | Optional                |  |  |
| 4       | -Vin        | Negative input voltage  |  |  |
| 5       | -Vout       | Negative output voltage |  |  |
| 6       | +Vout       | Positive output voltage |  |  |

# **Pin Specification:**

Pins 1-4 1.00mm (0.040") diameter Pins 5 &6 1.50mm (0.059") diameter

All pins are copper with Tin plating.

# PART NUMBERING SYSTEM

| Q           | 48         | S          | K          | 120       | 33       | N            | R          | F               | Α                      |
|-------------|------------|------------|------------|-----------|----------|--------------|------------|-----------------|------------------------|
| Form        | Input      | Number of  | Product    | Output    | Output   | ON/OFF       | Pin        |                 | Option Code            |
| Factor      | Voltage    | Outputs    | Series     | Voltage   | Current  | Logic        | Length     |                 |                        |
| Q - Quarter | 48-36V~75V | S - Single | K- QB high | 120 - 12V | 33 - 33A | N - Negative | K - 0.110" | F - RoHS 6/6    | A - Std. Functions     |
| Brick       |            |            | power      |           |          | P - Positive | N - 0.146" | (Lead Free)     | without case pin       |
|             |            |            | series     |           |          |              | R - 0.170" | Space - RoHS5/6 | H - with heat spreader |
|             |            |            |            |           |          |              |            |                 | and case pin           |
|             |            |            |            |           |          |              |            |                 | N - with heat spreader |
|             |            |            |            |           |          |              |            |                 | and without case pin   |

# **MODEL LIST**

| MODEL NAME     | INPUT   |     | OU. | TPUT | EFF @ 100% LOAD |
|----------------|---------|-----|-----|------|-----------------|
| Q48SK12033NRFA | 36V~75V | 13A | 12V | 33A  | 95.5%           |
| Q48SK12033NRFH | 36V~75V | 13A | 12V | 33A  | 95.5%           |
| Q48SK12033NNFH | 36V~75V | 13A | 12V | 33A  | 95.5%           |

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales

### CONTACT: www.delta.com.tw/dcdc

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<sup>\*</sup> For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.